



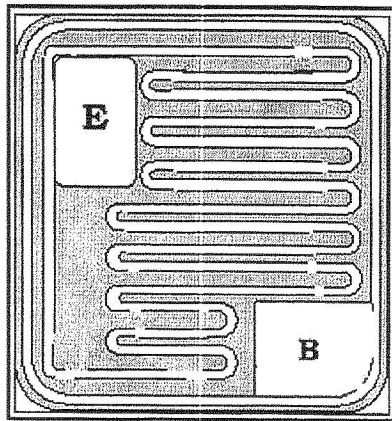
Sierra Components, Inc.

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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.

99 mils



93 mils

Topside Metal: Aluminum
Backside Metal: AuAsNiAg
Backside Potential: Collector
Bond Pad Size: .004" Min.
Mask Ref: 007118

MFG: Fairchild

THICKNESS: .008"

Part # D44H11

APPROVED BY: R Bacon

DIE SIZE : .093"x .099"

DATE: 3/4/10